

# HTST80 型机械密封

## 运行参数

压力: 0~2.5Mpa

温度: -20℃~200℃

转速: ≤20m/s

介质: 油、水、盐、碱、有机溶剂等。

动、静环材料: 碳化硅-碳化硅、浸渍树脂(金属)石墨-碳化硅

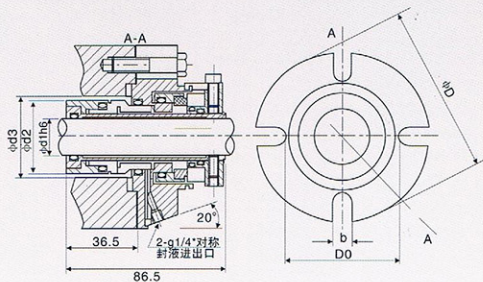
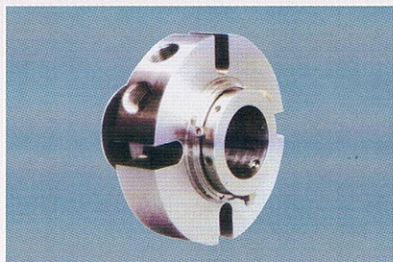
Pressure: 0~2.5Mpa

Temperature: -20℃~200℃

Rotating speed: ≤20m/s

Medium: oil, water, salt, base, organic solvent and so on.

Materials for rotating and ring: carborundum-carborundum, Impregnating resin (metal) graphite-carborundum.



d	d2	d3(man)	d3(man)	D	D0	b
25	43	44	51	105	62	12
28	46	47	52	105	65	12
30	48	49	56	105	67	12
32	49.8	51	57	110	70	12
33	49.8	51	57	110	70	12
35	53	54	61.5	115	72	12
38	56	57	66	125	75	12
40	58	59	68	125	77	14
42	60.5	61.5	69.5	133	80	14
43	61	62	70.5	133	80	14
45	62.5	64	73	141	82	14
48	65.6	67	75	141	85	14
50	68	69	78	150	87	14
55	73	75	83	150	92	18
60	78	80	91	157	102	18
65	84.8	87	98.5	165	109.3	18
70	93	95	108	180	118.3	18